

## SCOPE OF ACCREDITATION Chemical Processing

## **Epner Technology**

25 Division Pl Brooklyn, NY 11222-5204

This certificate expiration is updated based on periodic audits. The current expiration date and scope of accreditation are listed at: www.eAuditNet.com - Online QML (Qualified Manufacturer Listing).

In recognition of the successful completion of the PRI evaluation process, accreditation is granted to this facility to perform the following:

AC7108 Rev F - Nadcap Audit Criteria for Chemical Processing
CONVERSION COATING
Aluminum
Copper
Other Copper
Ovens Used at a Set Point Above 250°F
Ovens Used at a Set Point of 250°F or Below
PLATING
Electroforming
Copper
Nickel
Electroless Plating
Copper
Nickel
Other Nickel
Electroplating
Alloy Plating
Cadmium Plating
Other Cadmium Plating
Copper Plating
Other – Copper Plating
Gold Plating
Other Gold Plating
Nickel Plating
Other Nickel Plating

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Rhodium Plating Silver Plating Tin Plating Other Tin Plating
Stripping of Coatings Inorganic Coatings
Testing Performed Internally In Support of the Chemical Process Accreditation B10 – Adhesion Testing (Adhesion Tape Testing) In Support of AC7108 B12 – Adhesion Testing (Bend Test) In Support of AC7108 B13 – Coating Weight Testing In Support of AC7108 B16 – Coating Thickness Measurement In Support of AC7108 B17 – Solderability Test In Support of AC7108 B18 – Adhesion Testing (Heat & Quench ) In Support of AC7108 Solution Analysis In Support of AC7108